



LATIN AMERICA POSTGRADUATE SCHOLARSHIP

Bond University offers high achievers from Latin America tuition remission scholarships. The scholarships are awarded on the basis of academic excellence and are a testament to Bond University's commitment to quality and outstanding international students.

ELIGIBILITY DETAILS

High achieving citizens of a country within Latin America who are currently residing inside or outside of Australia are encouraged to apply. Applicants must have received an offer to study at Bond prior to applying.

Examples of high academic achievement may include students with high achieving A Level, IB, Australian HSC qualification results (or equivalent from their home country qualification) or high GPA's in their Bachelor degree studies.

APPLICATION DEADLINES

Applications close on 3 April, 2020 for students commencing in the May 2020 semester.

Applications close on 30 June, 2020 for students commencing in the September 2020 semester.

Applications close on 16 October, 2020 for students commencing in the January 2021 semester.

ABOUT BOND UNIVERSITY

Bond University is Australia's first private, not-for-profit university, offering a personalised academic environment that enables graduates to exceed the outer limits of their potential.

With access to unparalleled academic and technological resources on Bond's world-class Gold Coast campus, students thrive in smaller study groups where eminent professors and industry experienced lecturers know them by name.

For over a decade, Bond has stood strong as Australia's number one university for student experience, achieving more 5-star ratings for Student Experience than any other university in Australia, according to the 2020 Good Universities Guide. Bond University is also the highest ranking Australian university for Employer Satisfaction of our graduates as rated on the Quality Indicators for Learning and Teaching (QILT) website, 2020.

SCHOLARSHIP VALUE

Recipients are awarded a AUD\$10,000 tuition fee scholarship (paid in two \$5,000 instalments over the first two semesters). Scholarships are not available for some programs, visit bond.edu.au/scholarships/LatinAmerica for full details.

APPLICATION PROCESS

Students must complete the Bond University Online Application Form at bond.edu.au/apply to receive their program offer before applying for this scholarship.

The Latin America Postgraduate Scholarship Application Form can be downloaded at bond.edu.au/scholarships/LatinAmerica and must be completed in full and returned to international@bond.edu.au by the application closing date.

FURTHER INFORMATION

For further information, please visit bond.edu.au/scholarships/LatinAmerica.